Noise Suppression Products/EMI Suppression Filters > Chip EMIFIL® Inductor Type > for GHz Noise Chip Ferrite Beads

Data Sheet

1 Chip EMIFIL[®] Inductor Type for GHz Noise Chip Ferrite Beads BLM15E Series (0402 Size) Dimension Equivalent Circuit 0.25+0. 0.5±0.05 ()1.0±0.05 (Resistance element becomes dominant 0.5±0.05 at high frequencies.)

Packaging

Code	Packaging Minimum Quan			
D	180mm Paper Tape	10000		
J	330mm Paper Tape	50000		
В	Bulk(Bag)	1000		

(in mm)

■ Rated Value (□: packaging code)

Part Number	Impedance (at 100MHz/20°C)	Impedance (at 1GHz/20°C)	Rated Current	DC Resistance(max.)	Operating Temperature Range
BLM15EG121SN1	120ohm±25%	145ohm(Typ.)	1500mA	0.095ohm	-55°C to +125°C
BLM15EG221SN1	220ohm±25%	270ohm(Typ.)	700mA	0.28ohm	-55°C to +125°C

Number of Circuits: 1

Continued on the following page.

This data sheet is applied for CHIP FERRITE BEAD used for General Electronics equipment for your design.

[∆] Note:

1. This datasheet is downloaded from the website of Murata Manufacturing co., Itd. Therefore, it's specifications are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering.

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Data Sheet

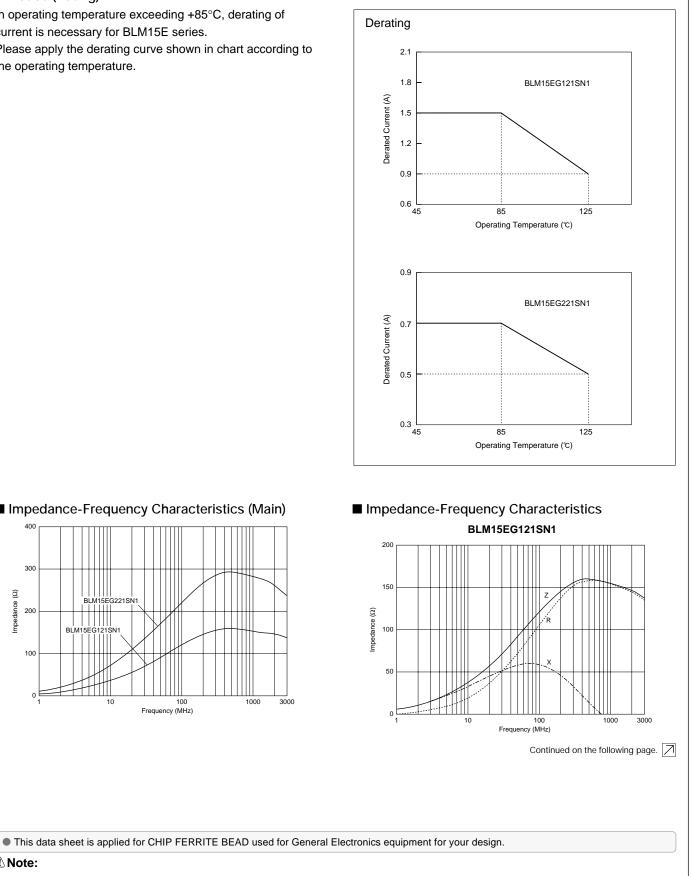
Continued from the preceding page.

■ Notice (Rating)

In operating temperature exceeding +85°C, derating of

current is necessary for BLM15E series.

Please apply the derating curve shown in chart according to the operating temperature.



Impedance-Frequency Characteristics (Main)

300 mpedance (Ω) 2215N 200 100 0 E 10 100 1000 3000 Frequency (MHz)

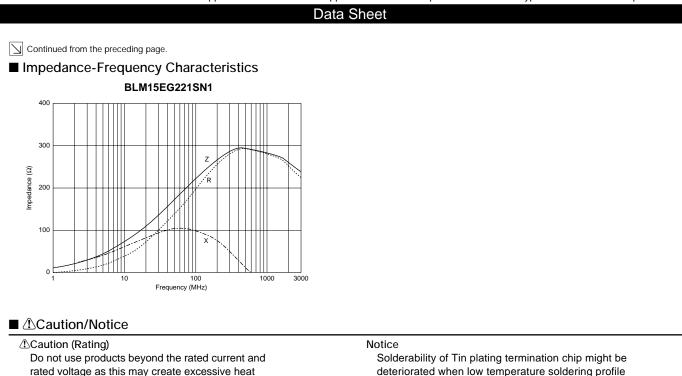
∆ Note:

400

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and deteriorate the insulation resistance.

Solderability of Tin plating termination chip might be deteriorated when low temperature soldering profile where peak solder temperature is below the Tin melting point is used. Please confirm the solderability of Tin plating termination chip before use.

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